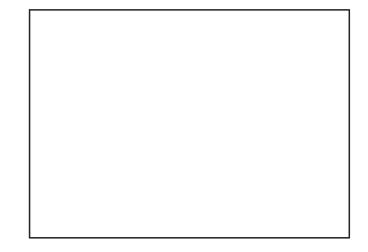


TABLE 1

Variant	Label text
001	ChangeMe!
002	ChangeMe!

## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9707	REV: A	SUN REV:	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 4/25/2	2014 3: 43: 44	PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9707	REV: A	SVN REV: Not In VersionControl	
		IGNORE ->	r l ay	Bottom Ove
PLOT NAME = Bottom Assembly Drawing	GENERATED : 4/25/2	2014 3: 43: 45	PM	TEXAS INSTRUMENTS

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